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Evolution and impact of defects in a p-channel CCD after cryogenic proton-irradiation

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Abstract—P-channel CCDs have been shown to display improved tolerance to radiation-induced charge transfer inefficiency (CTI) when compared to n-channel CCDs. However, the defect distribution formed during irradiation is expected to be temperature dependent due to the differences in lattice energy caused by a temperature change. This has been tested through defect analysis of two p-channel e2v CCD204 devices, one irradiated at room temperature and one at a cryogenic temperature (153K). Analysis is performed using the method of single trap pumping. The dominant charge trapping defects at these conditions have been identified as the donor level of the silicon divacancy and the carbon interstitial defect. The defect parameters are analysed both immediately post irradiation and following several subsequent room-temperature anneal phases up until a cumulative anneal time of approximately 10 months. We have also simulated charge transfer in an irradiated CCD pixel using the defect distribution from both the room-temperature and cryogenic case, to study how the changes affect imaging performance. The results demonstrate the importance of cryogenic irradiation and annealing studies, with large variations seen in the defect distribution when compared to a device irradiated at room-temperature, which is the current standard procedure for radiation-tolerance testing.

Index Terms—Divacancy, CCD, p-channel, defect, pocket pumping, radiation damage, Carbon, trap pumping

I. INTRODUCTION

Radiation-induced defects are responsible for charge-transfer performance degradation in CCDs because they introduce stable deep-levels within the silicon band-gap, which are capable of trapping a single charge carrier ($h^+$ for the p-channel case) for a length of time before emission [1]. This time is heavily temperature dependent and is defined as the defect emission time-constant ($\tau_e$). Where the emission time-constant at a given temperature is close to the line transfer time of the CCD, charge carriers can be moved efficiently between adjacent charge-packets, leading to image smearing [2] which is detrimental to the science goals of the detector [3].

P-channel CCDs have demonstrated improved tolerance to radiation damage induced image degradation because the predominant defects produced, which are the donor level of the silicon divacancy and the carbon interstitial defect, both have emission time-constants which interfere less with the typical CCD operating conditions at nominal space-based detector temperatures than in the n-channel case [4]. These two defects have been studied extensively with the donor level of the divacancy established as having an energy level of around $E_v + 0.20$ eV [5][6][7] and the carbon interstitial an energy level of $E_v + 0.27$ eV [8][9].

However, previous studies have also shown considerable uncertainty in the defect emission time-constants, of up to an order of magnitude [10]. It is therefore vital both for a complete comparison between n- and p-channel CCDs and for future mitigation of radiation-induced CTI to study with high precision the parameters of defects produced in p-type silicon post-irradiation. Another important factor to account for is the device temperature during irradiation, as this affects the lattice energy and therefore the defect formation and interaction rates. An initial analysis of the effect of temperature was carried out in [11] and showed considerable differences in the initial defect distributions, as well as following a room-temperature anneal of up to approximately 1 month. Here we continue this analysis to investigate the longer term effects of such an irradiation as well as the potential impact on device performance.

II. TRAP PUMPING

The charge trapping process is described by Shockley-Read-Hall kinetics [12][13] which models the capture and release of electrons (or holes) through the use of two exponential time constants; the capture time-constant and emission time-constant, as shown in Equations 1 and 2. These contain terms for the thermal velocity of a hole and the effective density of states in the valence band, as given in Equations 3 and 4. Here $\sigma$ is the cross-section, $n$ is the electron concentration at the trap location, $E$ is the energy of the level above the valence band edge and $m^{*}_{DOS,Con}$ are the effective hole masses for density of states and conductivity calculations respectively. The probability of capture or emission before a given time $t$ is then given by Equation 5.

\[
\tau_c = \frac{1}{\sigma n v_{th}} \tag{1}
\]
\[
\tau_e = \frac{1}{\sigma N_e v_{th}} \exp \left( \frac{E}{kT} \right) \tag{2}
\]
\[
N_v = 2 \left( \frac{2\pi m^{*}_{DOS}kT}{\hbar^2} \right)^{\frac{3}{2}} \tag{3}
\]
\[
v_{th} = \sqrt{\frac{3kT}{m^{*}_{Con}}} \tag{4}
\]
distribution post-irradiation. Under the conditions of this study used for comparison and to identify the most probable defect a room-temperature proton irradiation of a CCD204 were with protons at cryogenic temperature (153K). Results from defects produced in a p-channel CCD204 following irradiation seen in techniques such as DLTS [16].

To analyse the defect emission time-constants the method of trap pumping is used, which is described fully in [14] and [15]. The technique works by clocking signal charge from beneath an initial collecting phase electrode to beneath the same electrode in the next pixel, and back again. This is repeated over a number of cycles. For a defect beneath a barrier phase electrode there exists a probability per cycle of carrier capture from one charge packet and release into an adjacent charge packet. This is defined as the probability of pumping (shown in Equation 6) and depends on the emission time constant of the responsible defect as well as the time period \( t_{ph} \) (labelled as the phase time) between each charge transfer.

\[
P_p = \exp\left(-\frac{t}{\tau_e}\right) - \exp\left(-\frac{2t}{\tau_e}\right)
\]

If the probability is large enough then over a number of cycles \( N \) an image will be produced containing a signal dipole at the corresponding pixel; where a pixel significantly darker than the average background level neighbours a pixel significantly brighter, or vice-versa. The intensity of this signal dipole is defined as \( I = N \times P_p \). Differentiation of the expression for signal dipole intensity with respect to phase time gives an expression relating the phase time at maximum intensity to the emission time constant of the underlying defect. Therefore by analysing the intensity of such dipoles with varying \( t_{ph} \) we can probe the emission time constant of individual defects.

The technique also allows for analysis of defect energy levels if the process can be performed at a number of different temperatures. Since pocket pumping shows individual defect locations within the device, the emission time constant of a given defect can be tracked with changing temperature. Plotting \( \tau(e) \) against \( T \) allows for a fit based on Equation 2. Pocket pumping is therefore a powerful technique for defect analysis; specifically as it allows for the study of individual defects as opposed to the average effects of many defects as seen in techniques such as DLTS [16].

### III. Cryogenic Irradiation

Using the trap pumping method we have analysed the defects produced in a p-channel CCD204 following irradiation with protons at cryogenic temperature (153K). Results from a room-temperature proton irradiation of a CCD204 were used for comparison and to identify the most probable defect distribution post-irradiation. Under the conditions of this study two defect species dominate charge-transfer degradation; a donor level of the silicon divacancy \((VV+/0)\) and the carbon interstitial defect \((C_i)\) [10].

Measurements were performed at 153K post-irradiation and then subsequently after periods of approximately 1 day, 1 week, 1 month, 3 months and 10 months at room-temperature.

The e2v CCD204 is a 4k x 1k device which utilises a split output register with two separate output nodes. This device is a development chip towards the Euclid CCD273, with similar pixel architecture. The CCD204 has 12 \( \mu \)m square pixels and a channel width of 50 \( \mu \)m. A schematic of the CCD204 is shown in Figure 1. For this study two p-channel CCD204 devices were irradiated at the Synergy Health 5MV Tandem Accelerator (UK) [17].

One device was held at room-temperature during irradiation and received a 10MeV equivalent proton fluence of \( 2 \times 10^9 \text{cm}^{-2} \). A second device was held at cryogenic temperature (153K) and received a 10MeV equivalent fluence of \( 1.24 \times 10^9 \text{cm}^{-2} \). The irradiated regions were chosen such as to leave the output nodes unirradiated. Full details of the irradiation are outlined in [17]. All devices were held at 153K when not being tested or annealed. All of the results presented here have been scaled to the fluence received by the cryogenically irradiated device.

A cryogenic irradiation was performed in order to more closely mirror the conditions in a typical space-based detector as impinging particles strike the CCD and to monitor the effect this has on the defect distribution which is formed. The room-temperature irradiation results provided a start point for a comparison between the defect distributions formed in each temperature case.

Defect emission time-constant distributions immediately post-irradiation for both the room-temperature and cryogenically irradiated devices are presented in [11]. The initial defect distribution at 153K of the room-temperature irradiated device is shown in Figure 2(a). Initial results from this device showed the donor level of the divacancy to be by far the most abundant defect produced, with a dominant peak in the emission time constant distribution at 30 \( \mu \)s. Slower defects are also present but there is no clear second peak in the distribution corresponding to another defect species. The defect emission time constant distribution formed in the room-temperature irradiated device also shows a large spread around the main peak; with a mean emission time constant of approximately \( 40 \pm 20 \mu \text{s} \) at full width-half maximum (using the non-scaled distribution). The spread is therefore around 50 % and relates

![Fig. 1: A schematic of the e2v CCD204 showing the direction of charge transfer and the split serial register.](image-url)
well to the large emission time constant uncertainties seen in [10]. However using the method of trap pumping has allowed for the analysis of individual defect emission time constants with low (approximately 5 % [11]) and therefore it is determined that for the case of defects in a CCD the majority of this spread is a genuine and may arise from small fluctuations in temperature, electric field or other local effects such as stress. Another possible explanation is different orientations of the same defect within the lattice.

Initial results from the cryogenic device are shown in Figure 2(b) and show far fewer defects produced than in the room-temperature case. Although a small peak in the emission time constant distribution is present at typical divacancy range there is no clearly identifiable defect species present in large numbers.

Following analysis of the initial distributions a trap pumping method with a lower temporal resolution was used on the cryogenic device so that the technique could be run over a shorter period of time, allowing for study of the defect evolution in the first few hours after irradiation. The defect distribution was re-analysed every few hours over a period of several days until the first room-temperature anneal stage, with the number of divacancy defects tracked over time. The results are presented in [11] and are shown here in Figure 3(a).

For the first few days after irradiation there are small variations in the number of defects found, showing that the situation is still dynamic. This is shown more clearly in Figure 3(b) which is simply a zoomed in image of the initial hours from Figure 3(a). Defects may be mobile or able to dissociate/recombine even at cryogenic temperatures. Changes are still visible right up until the point of the first anneal stage, at around 120 hours after irradiation. The device was annealed for 26 hours at room-temperature before being cooled back down to 153K for testing. Immediately obvious is the large increase in the number of divacancy defects found after anneal, with the defect distribution more closely resembling the room-temperature device at this stage.

### IV. Annealing

Several room-temperature anneal stages were carried out resulting in a cumulative anneal time of approximately 10 months. A major advantage of trap pumping is the ability to identify individual defects which are present after each anneal stage and to monitor their emission time constants, energy levels and capture cross-sections on an individual basis [14]. The large number of defects present gives good statistics and therefore a highly accurate calculation of defect parameters.

A trap-pumping analysis of the cryogenic device was carried out after each anneal stage, producing the defect emission time-constant distribution for the nominal testing temperature of 153K. Results up until a total anneal time of 1 month were presented in [11], here we also include additional stages after total anneal times of approximately 3 and 10 months. Further analysis was completed at several temperatures between 143-173K at each anneal stage where the data was available. The temperature dependence of the emission time constant (see Equation 2) allows for a calculation of the defect energy level

![Graphs](image1.png)

(a) Room-temperature irradiated device. Included for reference are the literature value lines for the two defects of relevance at 153K [10].

![Graphs](image2.png)

(b) Cryogenically irradiated device, immediately post-irradiation.

![Graphs](image3.png)

(c) Cryo device following 1-day anneal.

![Graphs](image4.png)

(d) Cryo device following 1-week anneal.
(e) Cryo device following 1-month anneal.

(f) Cryo device following 3-month anneal.

(g) Cryo device following 10-month anneal.

Fig. 2: Defect emission time-constant distributions for both devices at various stages throughout the study. All testing was carried out at 153K. Each anneal stage was performed at room-temperature.

as outlined in the earlier trap pumping section. This can be used to identify the defect species present and confirm the time constant data.

Emission time constant distributions for all fitted defects at 153K following each anneal stage are shown in Figures 2(c) to Figure 2(g). Each shows a large peak around the expected divacancy emission time constant; however the situation is dynamic, with the divacancy distribution being non-Gaussian and containing two or more discernible peaks. From these distributions it appears as though many of the defects are moving and/or re-orienting over these time scales, and that the overall defect distribution is tending towards the room-temperature case, i.e. divacancy dominated with a second slower defect species corresponding to the carbon interstitial. The total number of defects found within our time range shows an increase over time even at the final stage tested, showing that the distribution is still changing after this length of time.

Following the further testing at several temperatures between 143-173K, defect energy levels were calculated for all defects which appear at every temperature. The energy distribution for the 1 day anneal stage was presented in [11] and showed two defect species consistent with the divacancy donor level and the carbon interstitial. Here the 1 month stage has been analysed, Figure 4, since this more closely resembles the final distribution. Defects included are those which were found when testing at 143K, 148K and 153K. The results

(a) Divacancy defects per pixel against time elapsed since irradiation, for the cryogenically irradiated device. Includes the 1-day anneal stage as specified.

(b) A zoomed in image of the first 120 hours after irradiation, showing that there are small variations whilst the device remains cold. Note the anomalous first data point, showing a reduced number of defects. The reason for this lower value is unknown but it could be that some defects had not yet stabilised within the lattice since the situation remains dynamic long after irradiation.

Fig. 3: Divacancy defects per pixel found in the cryogenically irradiated device post-irradiation using the trap-sweeping method.
do not differ appreciably from the values found at the 1 day anneal stage. We find for the large peak an energy level of \( E_v + 0.20(\pm 0.02) \) eV which is consistent with the value of \( E_v + 0.19 \) eV found by Mostek et al. [10] and earlier DLTS studies [5][6][7] for the divacancy donor level.

The smaller peak contains fewer defects and is distorted slightly by the spread from the much larger divacancy peak, but shows an approximate Gaussian energy distribution with an energy level of \( E_v + 0.26(\pm 0.02) \) eV. This is also consistent within uncertainties with the value of \( E_v + 0.28 \) eV found by Mostek et al. and earlier DLTS studies for the carbon interstitial level [8][9][10]. It should be noted however that previous studies have considered the overall effects of many defects, whereas the values quoted in this study come from the distributions of individually analysed defects, on which the measurement uncertainty is negligible compared to the width of the overall distribution.

We therefore believe that as expected the two defect species of interest are the donor level of the divacancy and the carbon interstitial. The energy distributions do not show any other noticeable peaks, which implies no other stable defect species are involved that can be detected. Therefore the separate time-constant peaks seen for both the divacancy and the carbon interstitial most probably relate to different orientations of the same defect. It is clear from the defect densities, locations and time-constants that there are large changes occurring in the defect distributions over these time scales at room-temperature.

Here we have seen that the effect of a room-temperature anneal on the defect distribution formed in a cryogenically irradiated device is significant and irreversible. Therefore a vital element of further work in this area is to study a device irradiated cryogenically and maintained at this temperature, such as a device would experience in space. It may be that given sufficient time the defects in both the room-temperature and cryogenically irradiated devices will reach the same final distribution. However the cryogenic case it may be that the lattice does not have enough energy for some processes to take place and so it could be that the final distributions diverge in each case. Further analysis of such devices is required both for improved understanding of the damage process and better context regarding device performance in a space environment.

V. CHARGE TRANSFER SIMULATIONS

As shown in Figure 1 the initial defect distribution differs greatly between the device irradiated at room-temperature and the device irradiated at 153K. It is therefore expected that there will be differences in the imaging performance of the two devices. To investigate this a Monte Carlo model of charge transfer in a radiation damaged CCD was used to simulate the effects of each defect distribution. The specific model used was the Open University Monte Carlo model (OUMC) which is described in [18]. The OUMC allows for the direct input of device specific electron density simulations and therefore does not require analytical assumptions about charge cloud density. The model can also take as an input a distribution of individual defect emission time constants; allowing for the defect distributions which have been found in each device through trap pumping to be analysed directly. A reduced number of defects was used for the device irradiated at room-temperature to account for the higher fluence received by this device.

For this work the OUMC modelled the effect of the two different defect distributions on charge transfer in a Euclid pixel (CCD273). Since the analysed region of each device was 400 rows by 600 columns, charge transfer was modelled using 400 parallel transfers and 600 serial transfers where appropriate. A single parallel shift consists of four steps

\[
t_{ph} = [t_{dwell} + t_{shift}, t_{shift}, t_{shift}, t_{shift}]
\]

where \( t_{dwell} \) is the time taken to read out the serial register, and \( t_{shift} \) is the time between each phase shift [18]. Two different parallel clocking schemes were simulated; a short scheme \([0.03313, 2.84 \times 10^{-5}, 2.84 \times 10^{-5}, 2.84 \times 10^{-5}] \) s and a long scheme \([0.0361, 0.003, 0.003, 0.003] \) s. The serial transfer time is \( 4.77 \times 10^{-6} \) s.

The first test uses an initial 5 pixel block of 400 electrons signal. The defect capture time is instantaneous for all defects, in order to simulate the realistic case where the capture time constant is much less than the dwell time. The First Pixel Response (FPR) and Extended Pixel Edge Response (EPER) are modelled after charge transfer simulations in three separate cases; the parallel short clocking scheme, the parallel long clocking scheme and the serial clocking scheme. The results are shown in Figure 4.

For the long parallel scheme there is only a small amount of deferred charge for both the room-temperature and cryogenic cases; with little difference between the two. This indicates that defects with longer time constants are the primary cause of CTI at these clocking rates, which is as expected since the transfer time is far apart from the typical divacancy emission.
time constant at this temperature. This is also shown by the
cryogenic case performing slightly worse for this clocking
scheme; corresponding to the higher density of defects with
long emission time constants.

The short parallel scheme shows significantly more deferred
charge; which is expected since the transfer time is now
closer to the divacancy emission time constant. The room-
temperature case performs noticeably worse for this scheme;
with approximately three times more deferred signal found
in the first extended pixel. This corresponds to the much
greater concentration of divacancy defects in this case. The
serial scheme shows little difference in the FPR between the
room-temperature and cryogenic cases, but approximately two
times more deferred charge is found in the first extended pixel
for the room-temperature case. This again shows the effect
of the greater density of faster defects arising from a room-
temperature irradiation.

A second test was performed using a point source with
a Gaussian filter, which was transferred in both the parallel
(short clocking scheme) and serial directions. The results are
shown in Figures 5 and 6. It can be seen that the results
match those from the first test; with greater charge spreading
in the parallel direction for the cryogenic case, and greater
spreading in the serial direction for the room-temperature case.
These simulations therefore give an example of the impact
on imaging performance of the different defect distributions
formed in a device irradiated at room-temperature and one
irradiated at cryogenic temperature. Depending on the nominal
temperature and clock timings the effect can be significant,
which shows the potential importance of cryogenic irradiation
studies for device characterisation.

VI. CONCLUSIONS

Using the method of trap pumping we have studied radiation
induced defects in a p-channel CCD irradiated with protons
at 153K. The defect emission time constants have been cal-
culated at various time intervals both immediately following
irradiation and after subsequent anneal phases up until a total
anneal time of approximately 10 months. This has allowed for
the analysis of longer term effects of such an irradiation on
the defects formed within the device.

Calculation of the defect energy levels show that the dom-
inant charge capturing defect under our operating conditions
and post-anneal is the donor level of the silicon divacancy,
with a calculated energy level of $E_v + 0.20(\pm 0.02)$ eV.
Also present is a carbon interstitial defect with an energy
$E_v + 0.26(\pm 0.02)$ eV. This is consistent with the defect
distribution formed with a room-temperature irradiation, how-
ever the dominant divacancy species only appears in the
cryogenic case after the first room-temperature anneal. A key
question for further work is the defect distribution in a device
irradiated and kept at cryogenic temperature without further
room-temperature anneal.

Whilst the energy distributions show two dominant defect
species, the emission time-constant distributions as well as
the defect densities and locations show dynamic changes
over these time scales. In particular more than one peak is

Fig. 5: FPR and EPER simulation results for a 5 pixel block of
charge transferred using 400 parallel transfers for each clock-
ing scheme and 600 serial transfers. Note the discontinuity in
the y-axis.
(a) The initial point source.

(b) The point source after transfer using the room-temperature defect distribution.

(c) The point source after transfer using the cryogenic defect distribution.

Fig. 6: Simulation results for a Gaussian point source given 400 parallel and 600 serial transfers using both the room-temperature and cryogenic defect distributions.

Fig. 7: A plot of the difference in electrons on a linear scale for the point source in the room-temperature case subtracted from the point source in the cryogenic case. This shows the increased spreading in the parallel direction for the cryogenic case, and the increased spreading in the serial direction for the room-temperature case.

observed in both the divacancy and carbon interstitial time-constant distributions at various times. Further investigation is therefore required in this area, such as analysis of any field or temperature dependencies of individual peaks. We also see small changes in the total number of defects within our detectable range right up until the final anneal stage.

The importance of cryogenic irradiation and annealing studies as opposed to the more standard technique of irradiating at room-temperature is apparent both because of the large differences in initial defect distributions and because of the major changes taking place during each anneal stage. It is also evident that if for a p-channel CCD a cryogenic irradiation results in a more favourable defect distribution than for the room-temperature case, then the device must be kept cold in order to maintain this distribution. Precise knowledge of defect parameters is vital in order to mitigate for radiation-induced CTI and so further analysis in this area provides scope for improved radiation tolerance of space-based detectors.

To analyse the potential impact of the different defect distributions which are produced for irradiation at room-temperature and at cryogenic temperature a model of charge transfer in a radiation damaged CCD was utilised. By simulating the effects of each distribution separately on both a 5 pixel block of charge and a Gaussian point source a comparison between the imaging performance in each case was obtained. It is shown that for certain temperatures and clocking schemes the effect can be significant, further stressing the importance of cryogenic irradiation studies for characterisation, particularly in the context of space missions.

Throughout this study we have considered only p-channel devices, and hence only hole traps. In n-channel devices, which remain the current standard for space-based detectors, similar studies into the effects of a cryogenic irradiation on the electron trap distribution are ongoing [19][20][21].
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